

#4/Re  
A  
12-16-01  
PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Daisuke OKAMURA et al.

Serial No. (unknown)

Filed herewith

METHOD OF RECYCLING MOLD PLASTIC  
PARTS FOR PHOTSENSITIVE MATERIAL  
AND A RECYCLED PLASTIC MOLD PARTS

PRELIMINARY AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Prior to the first Official Action and calculation of the filing fee, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please add the following paragraph between lines 16 and 17 in page 86:

A' ~~Table~~ Table 4 of Fig. 7 illustrates estimations of physical properties. The physical properties of recycled

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A<sup>1</sup>  
film units 2-5 are compared with that of a sample film unit  
1. ~~ex~~

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Respectfully submitted,

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By 

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